

### Surface Mount Switching Diodes

**(Pb)** Lead(Pb)-Free

**Feature:**

- \* Small plastic SMD package.
- \* Continuous reverse voltage: max. 75 V.
- \* High-speed switching in hybrid thick and thin-film circuits.

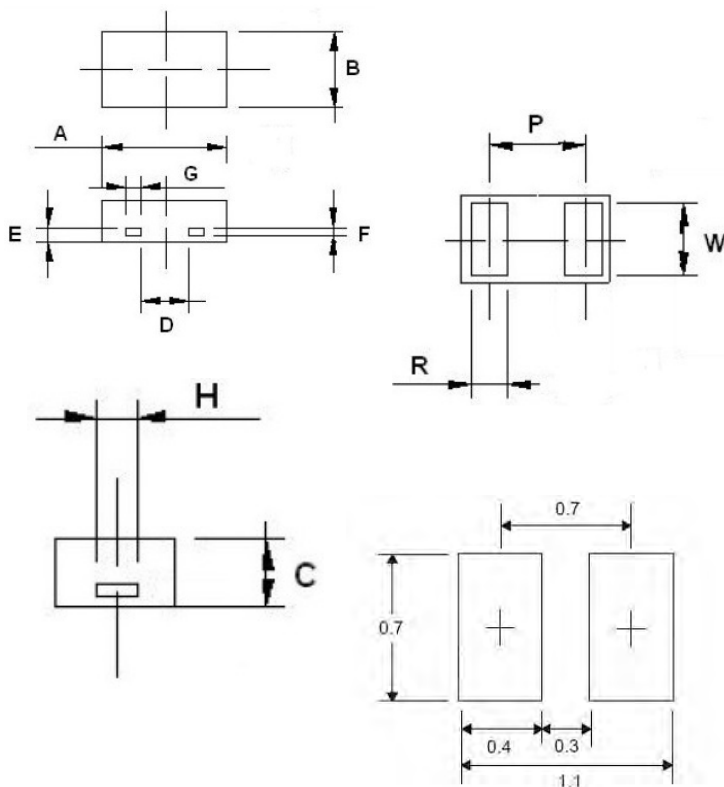
**SWITCHING DIODES**  
**500m AMPERES**  
**75 VOLTS**



**SOD-882**

### SOD-882 Outline Dimensions

Unit:mm



**SOLDERING FOOTPRINT**

MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.95	1.00	1.05
B	0.55	0.60	0.65
C	0.465	0.4825	0.5
D	0.39		
E	0.127		
F	0.0635		
G	0.12		
H	0.20		
P	0.64		
R	0.2	0.25	0.3
W	0.44	0.49	0.54

## Maximum Ratings (T<sub>A</sub>=25°C Unless otherwise noted)

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V <sub>R</sub>	75	V <sub>dc</sub>
Peak Forward Current	I <sub>F</sub>	200	mAdc
Peak Forward Surge Current	I <sub>FM</sub>	500	mAdc

## Thermal Characteristics

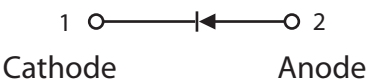
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board,* T <sub>A</sub> = 25°C Derate above 25°C	PD	200 1.57	mW mW/°C
Thermal Resistance Junction to Ambient	R <sub>θJA</sub>	635	°C/W
Junction and Storage Temperature	T <sub>j</sub> ,T <sub>stg</sub>	-55to+150	°C

\*\*FR-4 Minimum Pad

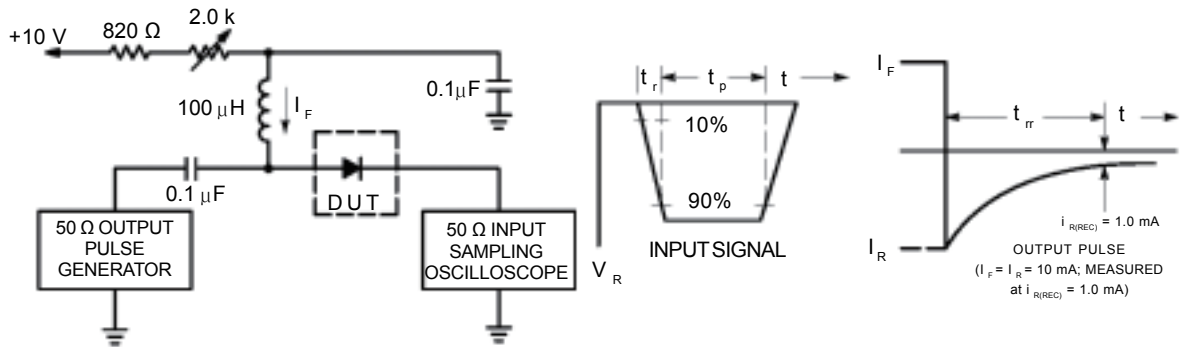
## Electrical Characteristics (T<sub>A</sub>=25°C Unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Voltage Leakage Current (V <sub>R</sub> = 75 Vdc) (V <sub>R</sub> = 75 Vdc, T <sub>J</sub> = 150°C) (V <sub>R</sub> = 25 Vdc, T <sub>J</sub> = 150°C)	I <sub>R</sub>	-	-	1.0 50 30	μAdc
Reverse Breakdown Voltage (I <sub>BR</sub> = 100 μAdc)	V <sub>(BR)</sub>	75	-	-	Vdc
Forward Voltage (I <sub>F</sub> = 1.0 mAdc) (I <sub>F</sub> = 10 mAdc) (I <sub>F</sub> = 50 mAdc) (I <sub>F</sub> = 150 mAdc)	V <sub>F</sub>	-	-	715 855 1000 1250	mV
Diode Capacitance (V <sub>R</sub> = 0, f = 1.0 MHz)	C <sub>D</sub>	-	-	2.0	pF
Forward Recovery Voltage (I <sub>F</sub> = 10 mAdc, t <sub>r</sub> = 20 ns)	V <sub>FR</sub>	-	-	1.75	Vdc
Reverse Recovery Time (I <sub>F</sub> = I <sub>R</sub> = 10 mAdc, R <sub>L</sub> = 50 Ω)	T <sub>rr</sub>	-	-	4.0	ns
Stored Charge (I <sub>F</sub> = 10 mAdc to V <sub>R</sub> = 5.0 Vdc, R <sub>L</sub> = 500 Ω)	Q <sub>s</sub>	-	-	45	pC

## Device Marking

Item	Marking	Equivalent Circuit diagram
BAS16BS	3*	 <p>1 ○ ——— &lt;— ○ 2 Cathode                      Anode</p>

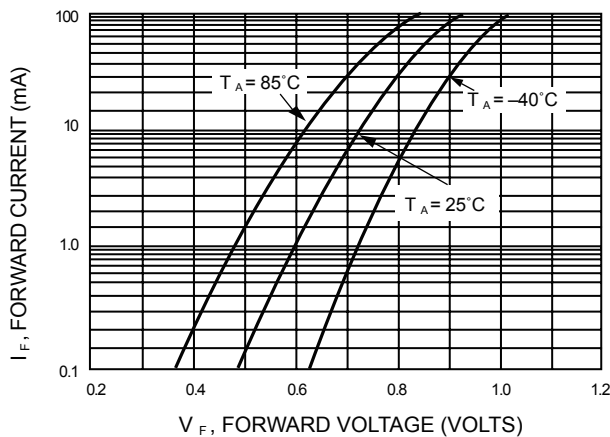
\*Rotated 90°



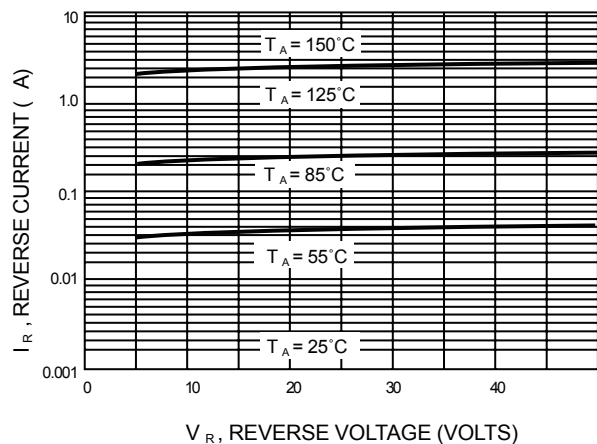
- Notes: 1. A 2.0 kΩ variable resistor adjusted for a Forward Current ( $I_F$ ) of 10mA.  
 2. Input pulse is adjusted so  $I_{R(peak)}$  is equal to 10mA.  
 3.  $t_p \gg t_{rr}$

**Figure 1. Recovery Time Equivalent Test Circuit**

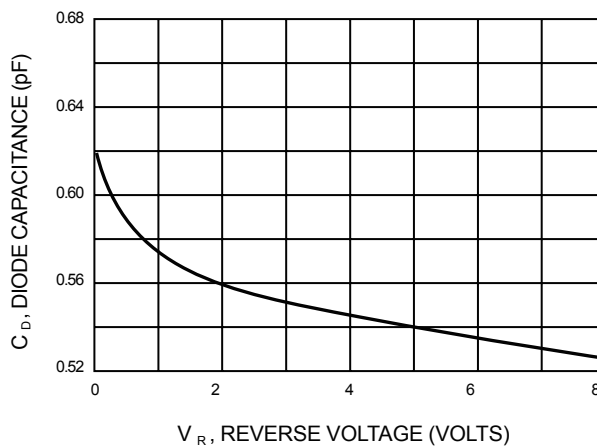
## TYPICAL CHARACTERISTICS



**Figure 2. Forward Voltage**



**Figure 3. Leakage Current**



**Figure 4. Capacitance**